

ASMT-TxBM-Nxxxx

Surface-Mount LED Indicator



Description

The Broadcom[®] ASMT-TxBM-Nxxxx Mini PLCC-2 SMT LEDs are designed specifically for use in interior automotive applications. They have a wide viewing angle of 120°, making them ideally suited for instrument cluster panel, push button, HVAC, and ambient decorative lighting applications in automotive interiors.

The LEDs are packed in EIA-compliant tape and reel to facilitate easy pick and place assembly. Every reel will be shipped in single intensity and color bin, to provide close uniformity.

Features

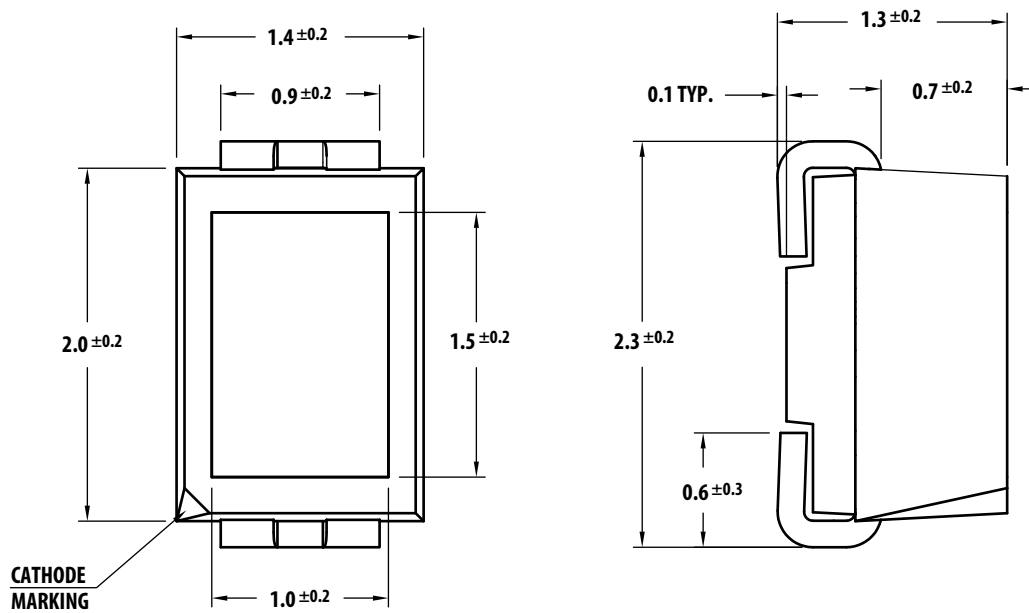
- Industry standard Mini PLCC-2
- High reliability LED package
- High brightness using InGaN dice technologies
- High optical efficiency
- Wide vertical viewing angle at 120°
- Available in 8-mm carrier tape on 7-inch reel
- Stable and consistent performance with minimum degradation
- JEDEC MSL 2

Applications

- Interior automotive
 - Instrument panel backlighting
 - Central console backlighting
 - Switch/push button backlighting

CAUTION! ASMT-TxBM-Nxxxx LED is Class 1B ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Broadcom Application Note AN-1142 for additional details.

Figure 1: Package Drawing



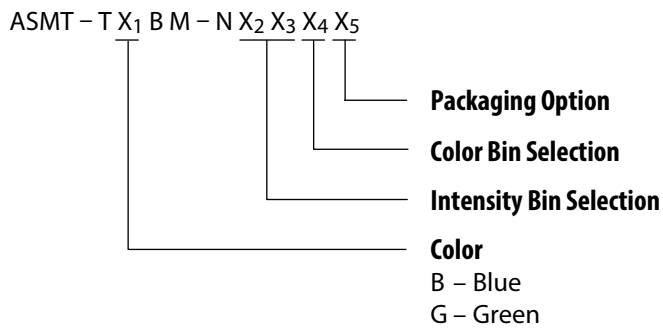
Device Selection Guide

Color	Part Number	Min. I _v (mcd)	Typ. I _v (mcd)	Max. I _v (mcd)	Test Current (mA)	Dice Technology
Blue	ASMT-TBBM-NS402	180.0	—	450.0	20	InGaN
Green	ASMT-TGBM-NT502	285.0	480.0	900.0	20	InGaN
Green	ASMT-TGBM-NU3B2	450.0	—	900.0	20	InGaN

NOTE:

1. The luminous intensity, I_v, is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
2. Tolerance = ±12%.

Part Numbering System



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$)

Parameters	ASMT-TBBM-Nxxxx	ASMT-TGBM-Nxxxx
DC Forward Current ^a	20 mA	
Peak Forward Current ^b	100 mA	
Power Dissipation	72 mW	
Reverse Voltage, V_R @ 10 mA	Not Recommended for Reverse Bias	
Junction Temperature	110°C	125°C
Operating Temperature	-40°C to +100°C	
Storage Temperature	-40°C to +100°C	

a. Derate linearly as shown in [Figure 6](#).

b. Duty Factor = 10%, Frequency = 1kHz.

Optical Characteristics ($T_J = 25^\circ\text{C}$)

Color	Part Number	Dice Technology	Peak Wavelength λ_{PEAK} (nm)	Dominant Wavelength ^a λ_D (nm)	Vertical Viewing Angle $2\theta_{1/2}$ ^b (Degrees)	Total Flux/ Luminous Intensity Φ_V (lm) / I_V (cd)
			Typ.	Typ.	Typ.	Typ.
Blue	ASMT-TBBM-Nxx02	InGaN	459.5	465.0	120	2.8
Green	ASMT-TGBM-Nxx02	InGaN	516.0	522.0	120	2.8

a. The dominant wavelength, λ_D , is derived from the CIE Chromaticity diagram and represents the color of the device.

b. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is half of the peak intensity.

Electrical Characteristics ($T_J = 25^\circ\text{C}$)

Part Number	Forward Voltage V_F (Volts) @ $I_F = 20$ mA			Thermal Resistance $R_{\theta_{JP}}$ ($^\circ\text{C}/\text{W}$)
	Min.	Typ.	Max.	
ASMT-TBBM-Nxxx2	2.8	3.2	3.6	230
ASMT-TGBM-Nxxx2	2.9	3.3	4.0	230

Figure 2: Relative Intensity vs. Wavelength

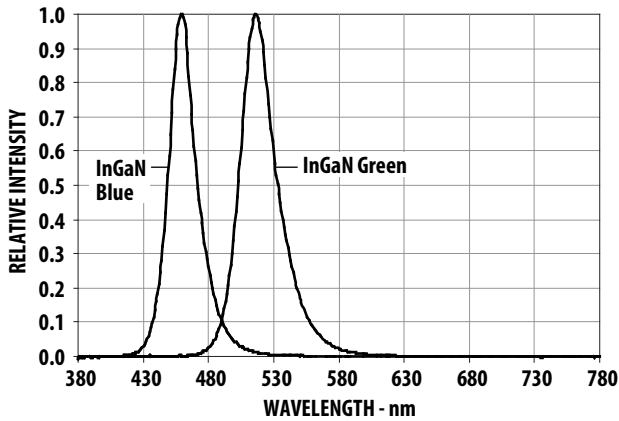


Figure 3: Forward Current vs. Forward Voltage

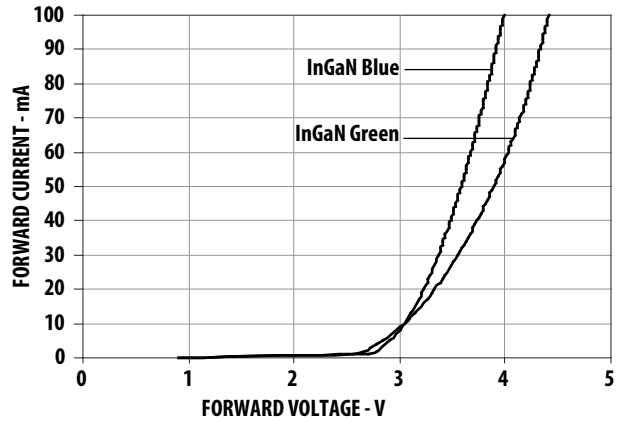


Figure 4: Relative Luminous Intensity vs. Forward Current

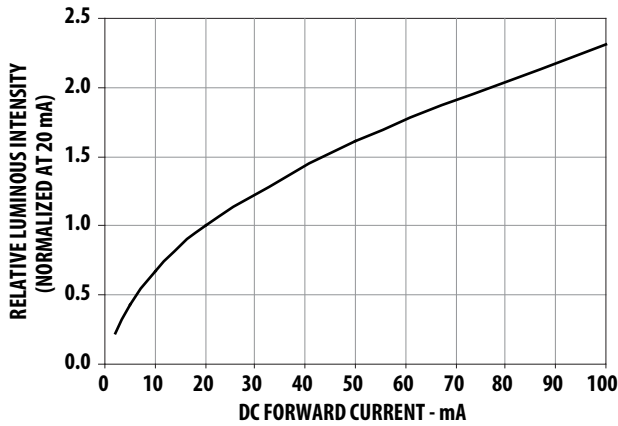


Figure 5: Relative Intensity vs. Temperature

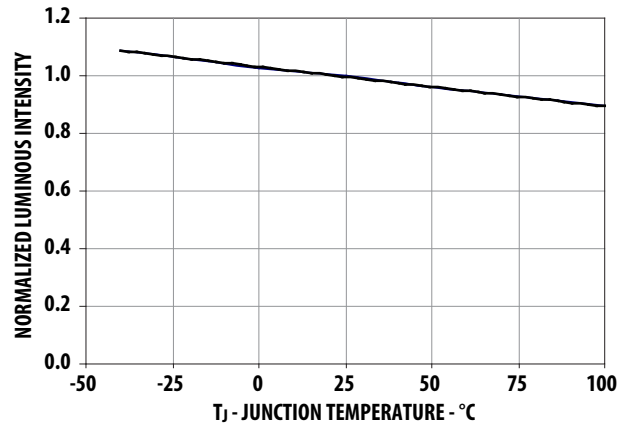


Figure 6: Maximum Forward Current Vs. Ambient Temperature. Derate Based on T_{JMAX} = 110°C, R_{θJA}=850°C/W, 480°C/W.

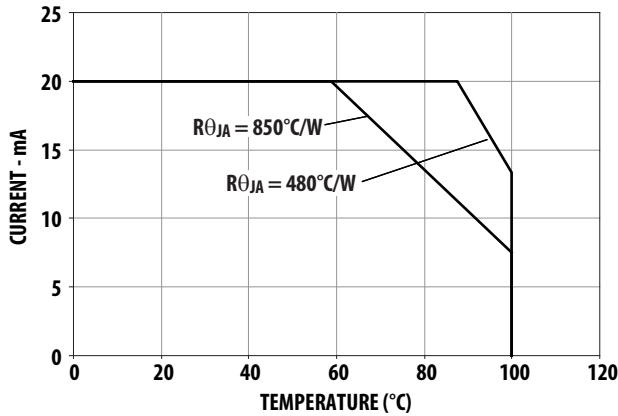


Figure 7: Dominant Wavelength Shift vs. Forward Current

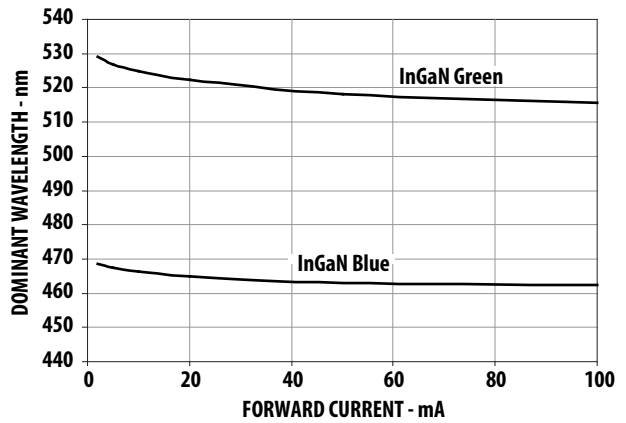


Figure 8: Forward Voltage Shift vs. Temperature

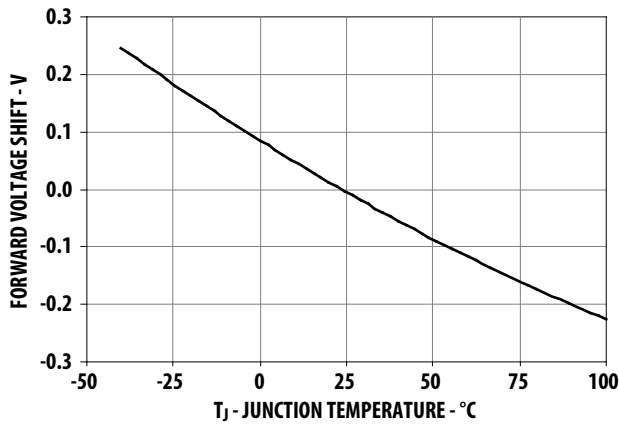


Figure 9: Radiation Pattern

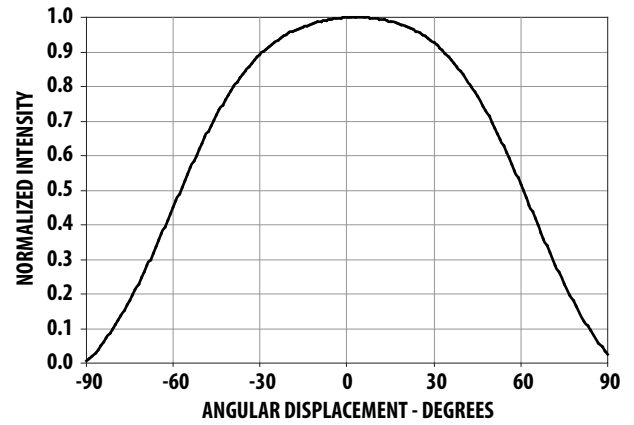


Figure 10: Recommended SnPb Reflow Soldering Profile

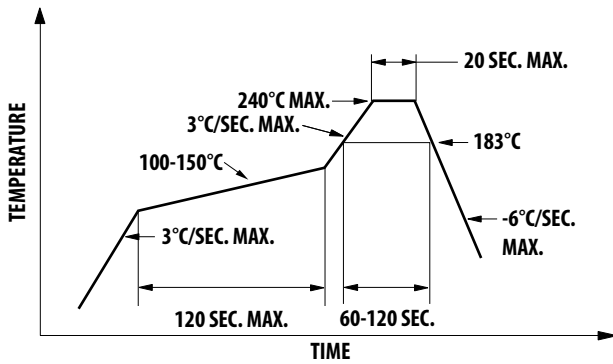


Figure 11: Recommended Pb-Free Soldering Profile

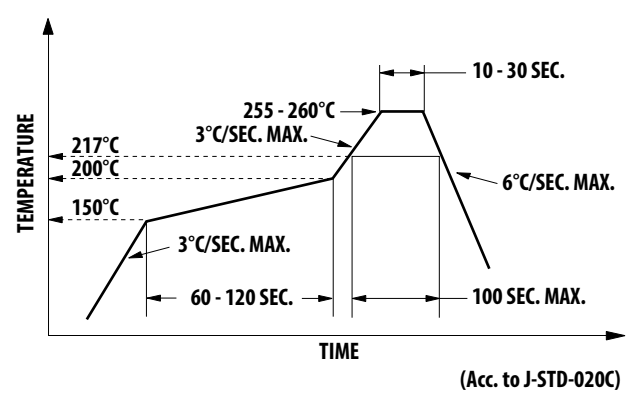


Figure 12: Recommended Soldering Pad Pattern

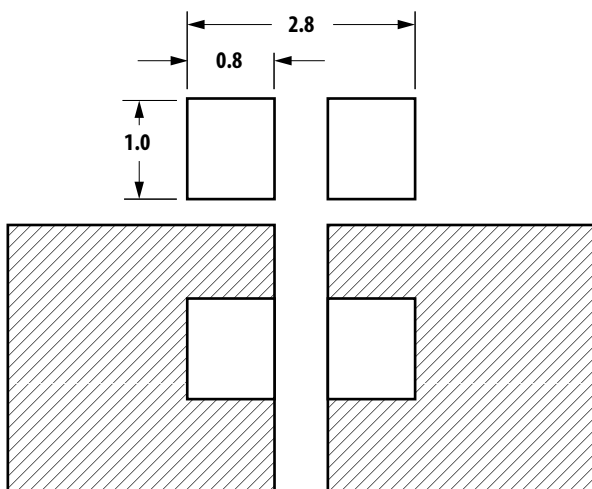


Figure 13: Tape Leader and Trailer Dimensions

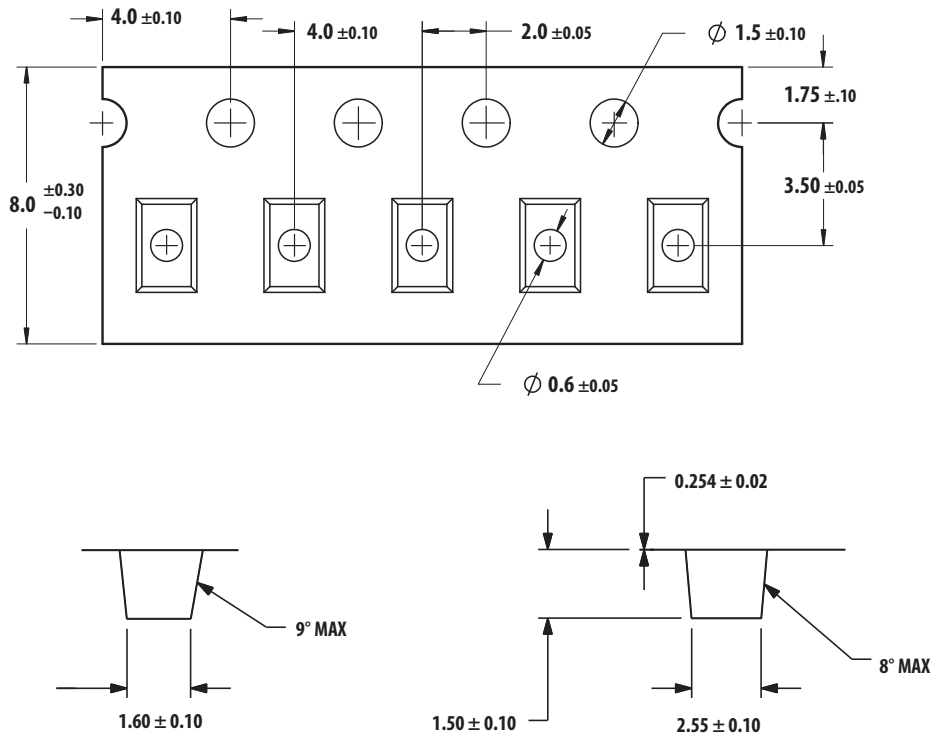
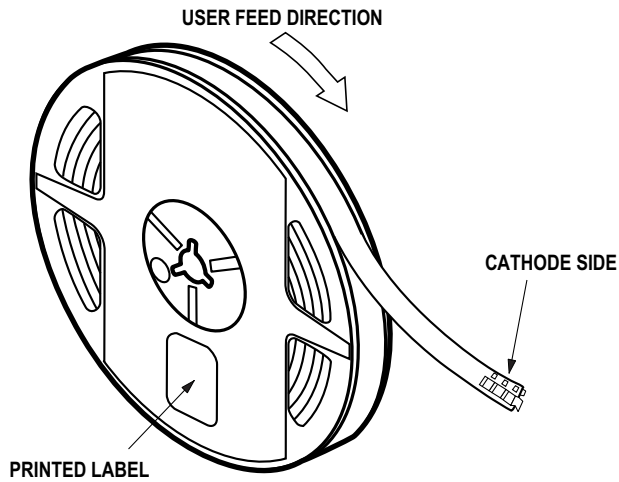


Figure 14: Reeling Orientation



Handling Precautions

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material; do not press on the silicone or poke a sharp object onto the silicone. These actions might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body only. Refer to Broadcom Application Note AN 5288 for detail information.

- Do not poke sharp objects into the silicone encapsulant. Sharp objects, such as tweezers or syringes, might apply excessive force or even pierce through the silicone and induce failures to the LED die or wire bond.
- Do not touch the silicone encapsulant. Uncontrolled force acting on the silicone encapsulant might result in excessive stress on the wire bond. Hold the LED only by the body.
- Do not stack assembled PCBs together. Use an appropriate rack to hold the PCBs.
- The surface of the silicone material attracts dust and dirt easier than epoxy due to its surface tackiness. To remove foreign particles on the surface of silicone, use a cotton bud with isopropyl alcohol (IPA). During cleaning, rub the surface gently without putting much pressure on the silicone. Ultrasonic cleaning is not recommended.

Moisture Sensitivity

This product is qualified as Moisture Sensitive Level 2a per JEDEC J-STD-020. Precautions when handling this moisture-sensitive product are important to ensure the reliability of the product. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices*, for details.

- Storage before use
 - Unopen moisture barrier bag (MBB) can be stored at < 40°C / 90% RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity indicator card (HIC) indicates that baking is not required, it is safe to reflow the LEDs per the original MSL rating.
 - It is not recommended to open the MBB prior to assembly (for example, for IQC).
- Control after opening the MBB
 - Read the HIC immediately upon opening the MBB.
 - Keep the LEDs at <30°C / 60% RH at all times and all high temperature-related processes, including soldering, curing, or rework, must be completed within 672 hours.

- Control for unfinished reel
 - Store any unused LEDs in a sealed MBB with desiccant or desiccator at < 5% RH.
- Control of assembled boards
 - If the PCB soldered with LEDs is to be subjected to other high-temperature processes, the PCB must be stored in a sealed MBB with desiccant or desiccator at < 5% RH to ensure no LEDs have exceeded their floor life of 672 hours.
- Baking is required if:
 - The HIC is *not* GREEN at 10% and is AZURE at 5%
 - The LEDs are exposed to condition of > 30°C / 60% RH at any time.
 - The LEDs floor life exceeded 672 hours.
 Recommended baking condition: 60°C ± 5°C for 20 hours.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- LEDs exhibit slightly different characteristics at different drive currents that might result in larger variations in their performance (that is, intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, it is crucial to ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- Do not use the LED in the vicinity of material with sulfur content, in environments of high gaseous sulfur compounds and corrosive elements. Examples of material that may contain sulfur are rubber gasket, RTV (room temperature vulcanizing) silicone rubber, rubber gloves, and so on. Prolonged exposure to such environments may affect the optical characteristics and product life.
- Avoid rapid changes in ambient temperature, especially in high humidity environments, as this will cause condensation on the LED.

Eye Safety Precautions

LEDs may pose optical hazards when in operation. It is not advisable to view directly at operating LEDs as it may be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipments.

Device Color (X₁)

B	Blue
G	Green

Intensity Bin Select (X₂X₃)

Individual reel will contain parts from one half bin only.

X ₂	
	Min I _V Bin

X ₃	
0	Full Distribution
2	2 half bins starting from X ₂ 1
3	3 half bins starting from X ₂ 1
4	4 half bins starting from X ₂ 1
5	5 half bins starting from X ₂ 1
6	2 half bins starting from X ₂ 2
7	3 half bins starting from X ₂ 2
8	4 half bins starting from X ₂ 2
9	5 half bins starting from X ₂ 2

Intensity Bin Limits

Bin ID	Min. (mcd)	Max. (mcd)
P1	45.0	56.0
P2	56.0	71.5
Q1	71.5	90.0
Q2	90.0	112.5
R1	112.5	140.0
R2	140.0	180.0
S1	180.0	224.0
S2	224.0	285.0
T1	285.0	355.0
T2	355.0	450.0
U1	450.0	560.0
U2	560.0	715.0
V1	715.0	900.0
V2	900.0	1125.0

Tolerance of each bin limit = ± 12%

Color Bin Select (X₄)

Individual reel will contain parts from one sub bin only.

X ₄	
0	Full Distribution
A	1 and 2 only
B	2 and 3 only
C	3 and 4 only
G	1, 2, and 3 only
H	2, 3, and 4 only
Z	Special binning

Color Bin Limits

Blue	Min. (nm)	Max. (nm)
1	460.0	465.0
2	465.0	470.0
3	470.0	475.0
4	475.0	480.0

Green	Min. (nm)	Max. (nm)
1	515.0	520.0
2	520.0	525.0
3	525.0	530.0
4	530.0	535.0

Packaging Option (X₅)

Option	Test Current	Package Type	Reel Size
2	20 mA	Top Mount	7 Inch

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